Calorimeter R&D

for the International Linear Collider

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ILC Physics and Calorimetry



Jet Energy Measurement



Problems:

Non-Compensation [hadr. vs. electrom. energy]

Missing energy [e.g. muon tracks]

Double counting [when using track momenta]

Particle Flow Calorimetry

Reduce role of 'hadron' calorimetry to measurement of n, $\rm K^0$

Compensating Calorimetry

Correcting hadronic energy for nuclear-binding energy loss.

Component	Detector	Fraction	Part. Resol.	Jet Energy Res.
Charged (X [±])	Tracker	60%	10 ⁻⁴ E _×	negligible
Photons (y)	ECAL	30%	0.1/ <i>J</i> Ε _γ	.06/√E _{jet}
Neutral Hadrons (h)	E/HCAL	10%	0.5/√E _{had}	.16/√E _{jet}



Particle Flow (PFA):

Choose detector best suited for particular particle type ...

i.e.: use tracks and distinguish 'charged' from 'neutral' energy to avoide double counting

distinguish electromagnetic and hadronic energy deposits for software compensation

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$$\sigma_{jet}^2 = \sigma_X^2 + \sigma_\gamma^2 + \sigma_{had}^2$$

.17/√E

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$$\sigma_{jet}^{2} = \sigma_{X}^{2} + \sigma_{\gamma}^{2} + \sigma_{had}^{2} \qquad .17/JE$$
$$+ \sigma_{confusion}^{2} + ... < .25/JE$$

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$$PFA - Energy Resolution:$$

$$\sigma_{jet}^{2} = \sigma_{X}^{2} + \sigma_{\gamma}^{2} + \sigma_{had}^{2}$$

$$+ \sigma_{confusion}^{2} + \dots$$

$$(25/JE)$$

Granularity more important than energy resolution !?

Overall Calorimeter Design HCAL HCAL **~** 5 λ 40 extra layers [2.5 cm/layer] Granularity: -3x3 cm² to 20x20 cm² (analog) - 1x1 cm² (digital) ECAL ~ 24 X₀ 30 - 40 layers [0.6 - 1.2 X₀] Granularity: - 5x5 mm² (analog) - $50 \times 50 \ \mu m^2$ (digital) ECAL

10⁷ to 10¹² readout channels [high-level of integration, low power consumption]

Silicon Tungsten Calorimeter



^{[...} similar approach: US SiD-Design]

Basic CALICE ECAL Design





Monolithic Active Pixel Digital ECAL /

CMOS

Wafer

Monotlithic Active Pixel Sensor Pixel size: 40x40 µm² Channel number: 8x10¹¹ Absorber: Tungsten Binary readout

Integration of sensor and readout electronics

Manfactured in standard CMOS process

Concerns:

MAPS:

Power consumption: 40 µW/mm² DAQ needs 400 Gbit/s



Sensor Layout (RAL) [0.18 Micron]

Digital ECAL: Shower Imaging



Simulation

Scintillator-Tungsten ECAL (Asia)

SiPM

[1600 pixels]



Scintillator-Tungsten ECAL (Asia)



Silicon Photomultipliers (SiPM)

SiPMs:

Pixelated APDs operated in limited Geiger mode

Signal = sum of fired pixels

MEPhi/Pulsar	: SiPMs
Hamamatsu	: MPPCs
SENSL	: SPMs
Photonique	: SSPMs
Voxtel	: MAPDs

Pros: small size, cheap, work in magnetic field

Cons: temperature & voltage dep., non-linearity, ...

Research in progress ...

SiPM [MEPhi/Pulsar]

used for



analog HCAL



up to 1600 pixels/mm²

MPPC [Hamamatsu]

> used for analog ECAL



1 m³-Prototype 38 layers

Sandwich structure:

- Scintillator Tiles+WLS+SiPMs (.5 cm)
- Stainless steel absorber (1.6 cm)





2006/2007 CERN Testbeam [2008 → Fermilab]

1 m³-Prototype 38 layers

Sandwich structure:

- Scintillator Tiles+WLS+SiPMs (.5 cm)
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2006/2007 CERN Testbeam [2008 → Fermilab]

3x3 cm² Tile

1 m³-Prototype 38 layers

Sandwich structure:

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2006/2007 CERN Testbeam [2008 → Fermilab]

Mounted SiPM

1 m³-Prototype 38 layers

Sandwich structure:

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2006/2007 CERN Testbeam [2008 → Fermilab]

Combined Test Beam Data:

- 100 Million Events collected
- Analysis ongoing

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2006/2007 CERN Testbeam [2008 → Fermilab]

Combined Test Beam Data:

- 100 Million Events collected
- Analysis ongoing
- ... next big step: technical prototype !

Analog HCAL - Test Beam Result



Analog HCAL - Test Beam Result



HCAL – The Digital Approach

Why digital ?

- better PFA performance
- cheap, robust detectors ...
- small total thickness ...

Used **Technologies**:

- GEMs
- µMegas
- RPCs



Example RPCs:

Pad Size: 1 × 1 cm² Total thickness: < 6 mm possible

Vertical Slize Test with 9 small chambers successful

Large Prototype to be built



Dual-Readout Calorimetry (4th)







Summary

Gaol: unprecedented jet energy resolution ILC: precision physics, Multi-Jet final states, low cross sections

Many interesting research projects High granular HCAL & ECAL (analog & digital), dual-readout calorimetry

Main approach: Particle Flow Algorithm (PFA) Granularity more important than energy resolution

Alternative: Cherenkov-assisted Hadron Calorimetry Dual read-out of cherenkov and scintillation light

Germany: Analog HCAL [incl. SiPMs & Electronics] DESY, Hamburg, Heidelberg, München, Wuppertal

Backups

Example: Higgs Self-Coupling

 $g_{\scriptscriptstyle hhh}$



Improvement of Jet Energy Resolution

60%/JE → 30%/JE

 \rightarrow 20% smaller uncertainty [equivalent of 40% luminosity increase]

Typical !



US ECAL Design (SiD)



Transverse: 12 mm² Longitudinal: 30 layers [0.7 - 1.4 X₀]

Energy resolution: ~ 17%/JE

US ECAL Design (SiD)





Analog HCAL – Technical Prototype

Goal: Compact & realistic design, i.e. scaleable with embedded electronics

Integration issues:

- readout architecture
- ultra-low power ASICs
- calibration system
- tile and SiPM integration
- absorber mechanics with minimal cracks

Feedback from test beam essential

[e.g. calibration concept, overall detector optimization]



Digital HCAL: GEM

Why digital ?

- better PFA performance
- cheap, robust detectors ...
- small total thickness ...





 $^{[30 \}times 30 \text{ cm}^2 \text{ GEM chamber}]$

A first Test chamber works - 80% Ar & 20 % CO₂ - Pad Size: ~ 1x1 cm²

Full size test beam module: 2008 [equipped with 100 x 30 cm2 chambers]

Digital HCAL: µMEGAS



Digital HCAL: RPCs



ILC Calorimeter $R_{\&D}$ – Overview

		L _	L		
ILC CALORIMETRY R&D			Detector Concept	Optimized for PFA	Compensating Calorimetry
ECALs	Silicon - Tungsten		SiD	Yes	No
	MAPS - Tungsten		LDC	Yes	No
	Scintillator – Tungsten		GLD	Yes	Yes
HCALS	Scintillator - Steel		4 th	No	Yes
	RPCs - Steel	_	Concept		
	GEMs - Steel				
	µMegas - Steel				
Dual- Readout	Scintillator – Steel				
тсмт	Scintillator - Steel				

ic Detector concepts





from Zaho et al.

Path to High Precision Hadron Calorimetry: Compensate for the Nuclear Energy Losses

- Compensation principle: $E = E_{obs} + k^* N_{nucl}$
- Two possible estimators of N_{nucl}:

N_{nucl} ~ N_{slow neutrons}
 N_{nucl} ~ (1-E_{em}/E_{tot})

Cherenkov-assisted hadron calorimetry: $E_{em}/E_{tot} \sim E_{Cherenkov}/E_{ionization}$

- 'EM' shower: relativistic electrons, relatively large amount of Cherenkov light
- 'hadronic' shower most of the particles below the Cherenkov threshold



Pb-Sci AHCAL

- Hardware compensation
 - Pb:Sc = 9.1:2
 - Strip/tile sizes are to be optimized
- > Strips

ilr

ÌİL,

- Better position resolution for same channel count
- Potential degradation of pattern recognition due to ghost hits



Design of Slab – Cross Section



The expected alveolar thickness is 6.5 mm if

 \Rightarrow Gaps (slab integration) : 500 μ m ?

- ➡ Heat shield : 400 µm ? but real thermal dissipation ? (active cooling ?)
- \Rightarrow PCB: 800 μ m (tolerances : ± ?) but chips embedded in PCB?
- ⇒ Thickness of glue : <100 µm ? study of the size of dots
- ⇒ Thickness of wafer : $320 \ \mu m (\pm ?)$ 30 matrix ordered ($90 \times 90 \ mm^2$)
- ⇒ Kapton[®] film HV feeding : 100 µm - OK (DC coupling)
- \Rightarrow Thickness of W : 2100 μ m (± 80 μ m)

Several technological issues have to be studied and validated



S.Schuwalov

.... Tasks of the Forward Region

ECal and Very Forward Tracker acceptance region.





•Precise measurement of the integrated luminosity ($\Delta L/L \sim 10^{-4}$) •Provide 2-photon veto

Provide 2-photon veto
Serve the beamdiagnostics using beamstrahlung pairs

•Serve the beamdiagnostics using beamstrahlung photons

<u>Challenges:</u>

High precision, high occupancy, high radiation dose, fast read-out!

o4.03.2008 S.Schuwalov

Impact of gaps on PFA

★ Assuming 60% charged particles, 30 % photons, 10 % neutral hadrons, can estimate contributions to PFA performance

45 GeV jets:		$\sigma_E = \alpha \sqrt{E}$						
α	ECAL	ECAL HCAL Confusion Other Total						
LDC00Sc	0.07	0.17	0.11	0.09	0.235			
LDC01_05Sc	0.14	0.17	0.12	0.09	0.267			

For LDC01_05Sc ECAL energy resolution is a significant contribution to jet energy resolution ! PandoraPFA v02-01



★ Ideally address this issue before mass reconstruction of samples.

Some preliminary answers to some PFA questions, e.g.



e.g. for PFA, what are the main detector questions ?

(at Snowmass LDC/GLD/SiD came up with list of questions) **★**Have "answers" to some of these questions (marked in green) The A-List (in some order of priority) 1) B-field : why 4 T ? Does B help jet energy resolution 2) ECAL inner radius/TPC outer radius 3) TPC length/Aspect ratio 4) Tracking efficiency – forward region 5) How much HCAL – how many interactions lengths 4, 5, 6... 6) Impact of dead material – see my talk on Wednesday 7) Longitudinal segmentation – pattern recognition vs sampling frequency for calorimetric performance 8) Transverse segmentation ECAL/HCAL ECAL : does high/very high granularity help? 9) Compactness/gap size 10) HCAL absorber : Steel vs. W, Pb, U... 11) Circular vs. Octagonal TPC (are the gaps important) 12) HCAL outside coil... 13) TPC endplate thickness and distance to ECAL 14) Material in VTX – how does this impact PFA

*****How about a similar list for Vertex and Tracking?

Status at LCWS07

★Full simulation studies using the LDC ILC detector concept with the PandoraPFA algorithm. Use $Z \rightarrow u\overline{u}, d\overline{d}, s\overline{s}$ decays at rest to benchmark performance



★For jet energies below 100 GeV achieve $\sigma_E/E < 0.30/\sqrt{E_{jj}({
m GeV})}$

★ Perhaps more importantly, for jet energies above ~75 GeV achieved

$$\sigma_{E_j}/E_j < 3.8\%$$

★ Post-LCWS emphasis shifted to improving low energy performance, important in likely initial phase of ILC at $\sqrt{s} \sim 200-500$ GeV

Particle Flow Performance



~ 50%/JE

~ 30%/√E





Integrated layer design





Design of the module...





The expected alveolar thickness is 6.5 mm if :

- \Rightarrow Gaps (slab integration) : 500 μ m OK
- ⇒ Heat shield : 400 µm ? but real thermal dissipation ? (active cooling ?)
- ⇒ PCB : 800 µm but chips embedded in PCB ?
- ⇒ Thickness of glue : 100 µm ? study of the size of dots ?
- \Rightarrow Thickness of wafer : 300 μ m ?
- ⇒ Ground or isolate foil : 100 µm ? AC vs DC ?
- \Rightarrow Thickness of W : 2100 μm OK

Several technological issues have to be studied and validated

Julien Fleury – EUDET/CALICE Electronic Meeting – 12 Jul 07

Chip Integration in PCB



- Bonding wires from Chip to PCB challenging due to large number of channels - Has to fit into overall mechanical to large above) 23

Chip on board design









Julien Fleury – EUDET/CALICE Electronic Meeting – 12 Jul 07